

FIG. 2

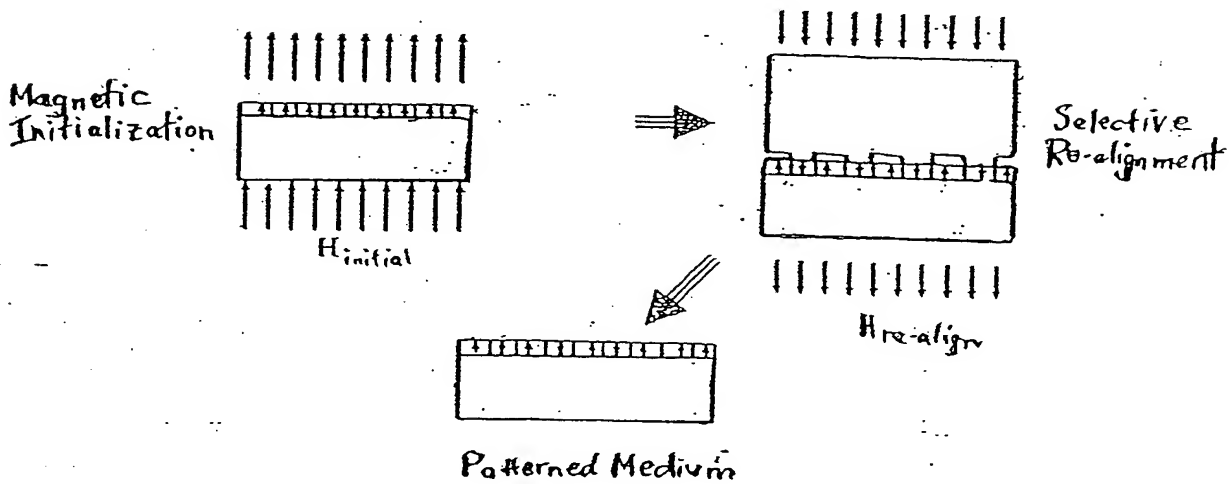


FIG. 3

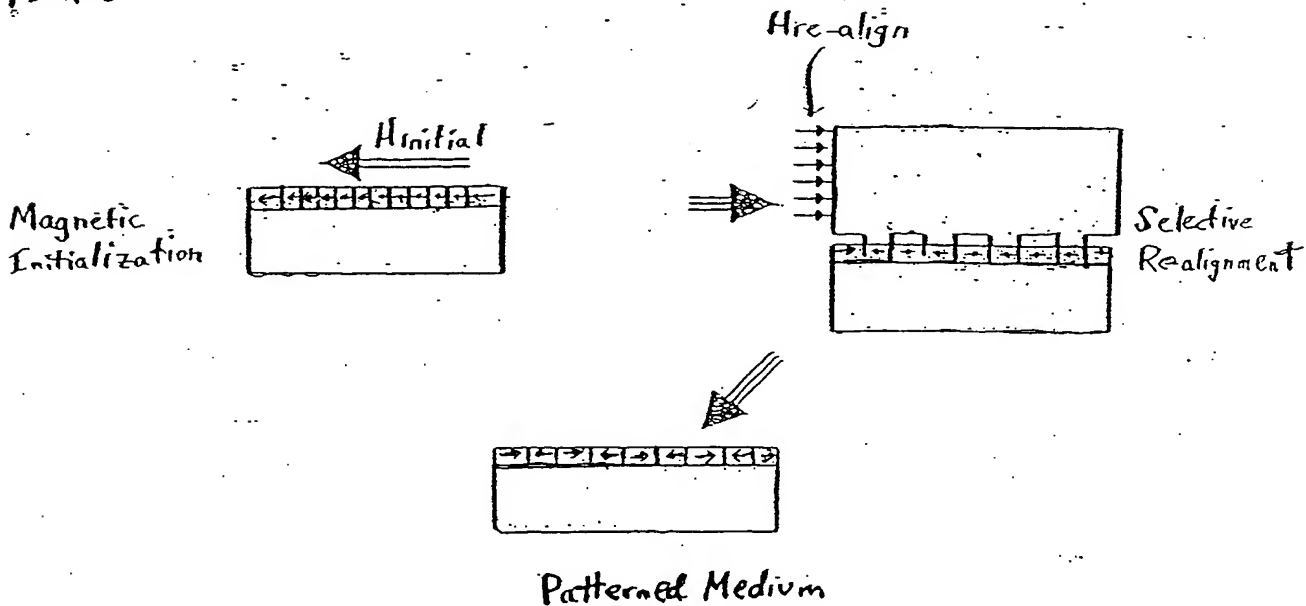


Fig. 4(A)  
(PRIOR ART)

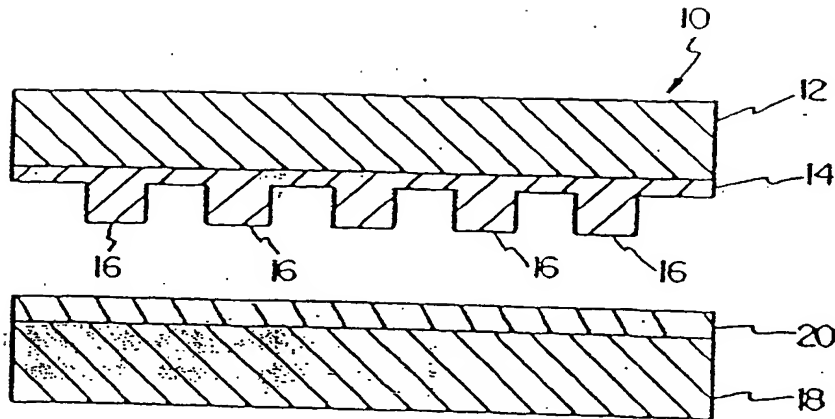


Fig. 4(B)  
(PRIOR ART)

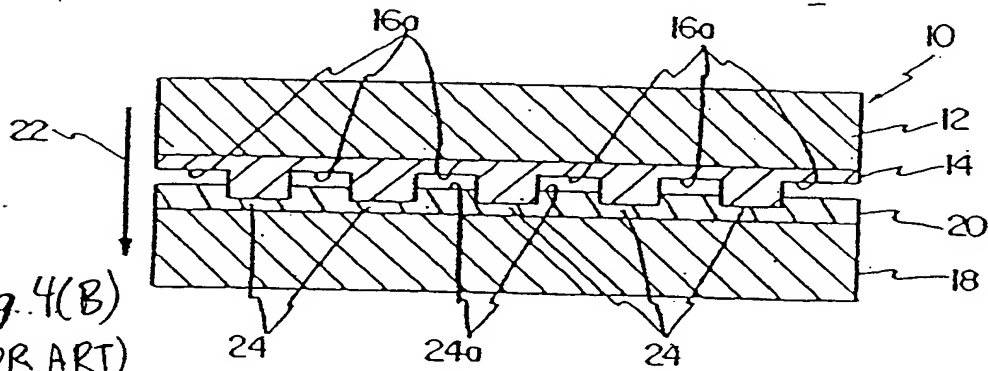


Fig. 4(C)  
(PRIOR ART)

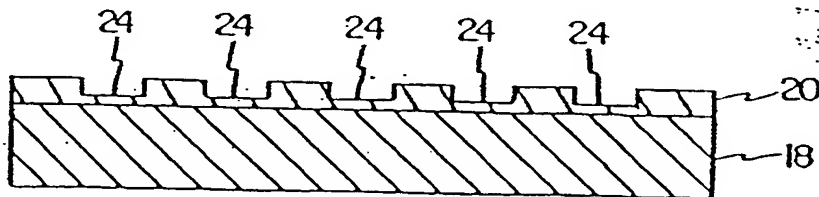
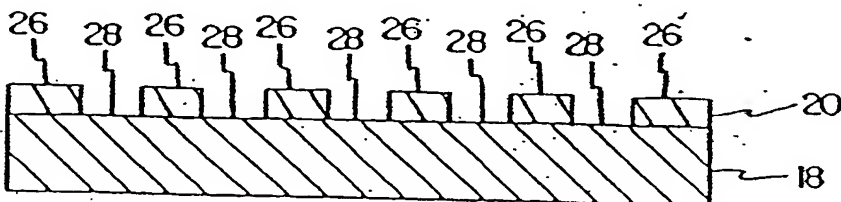


Fig. 4(D)  
(PRIOR ART)



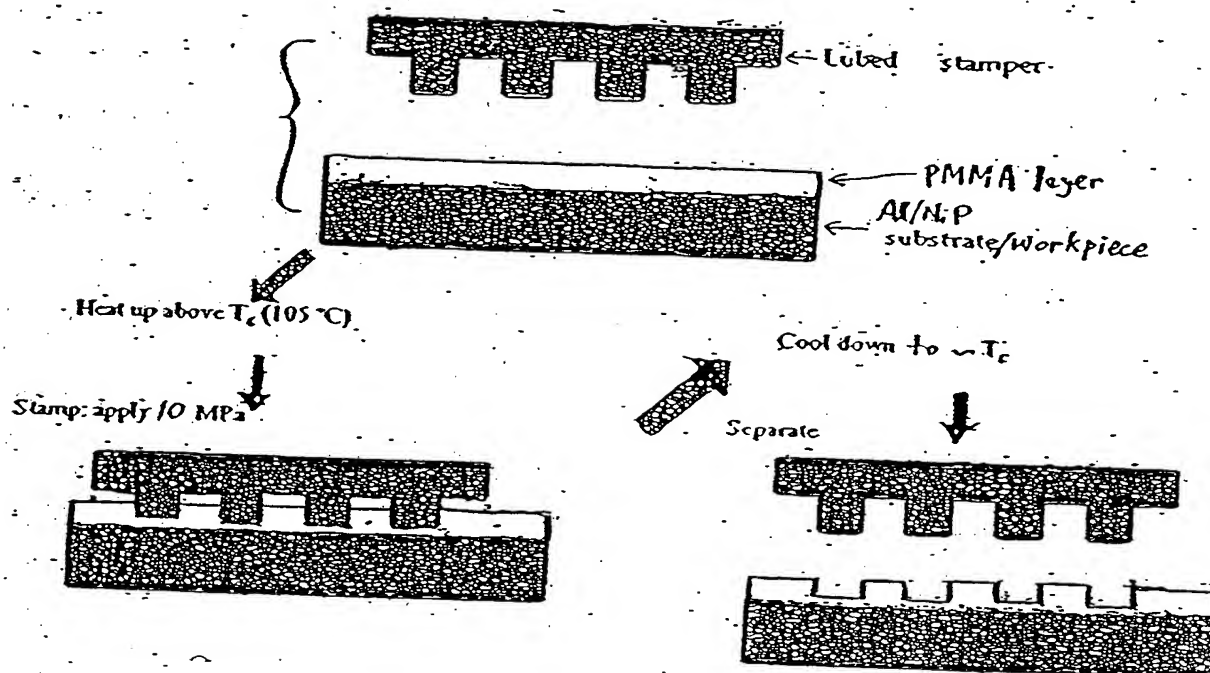


FIG. 5

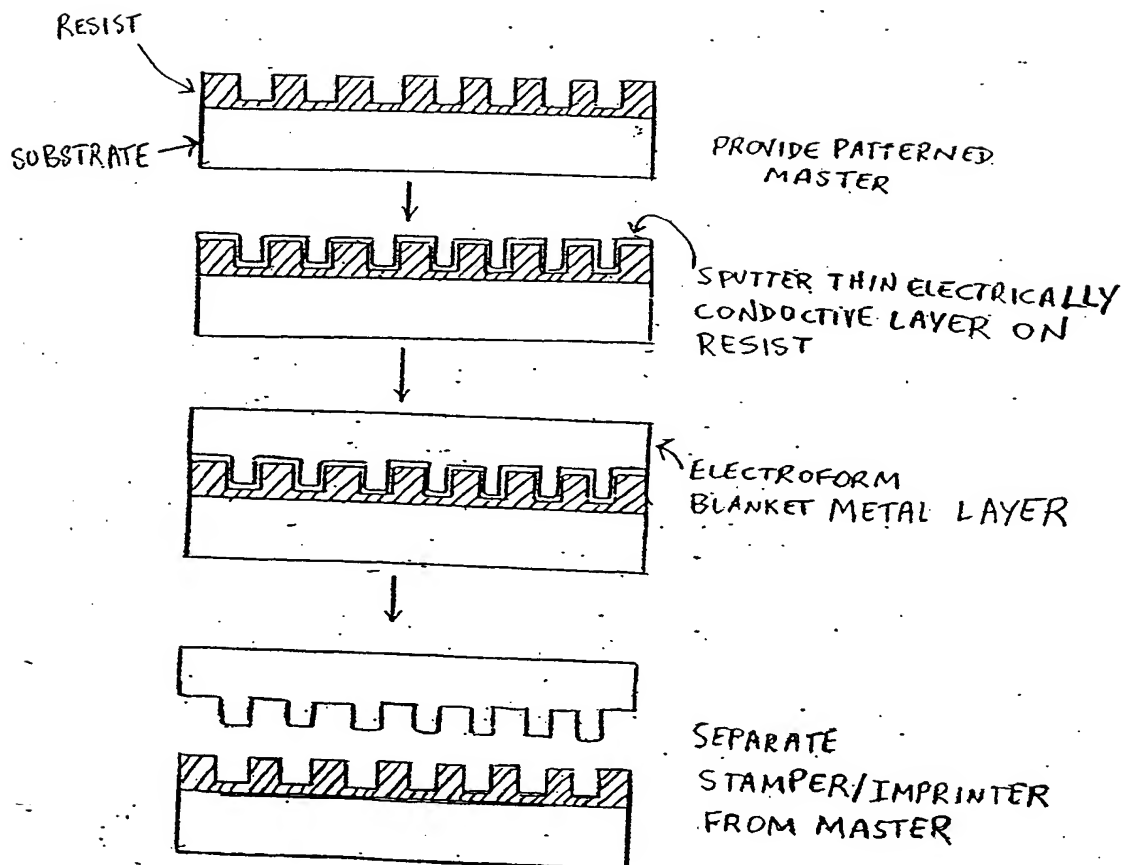


FIG. 6

FIG. 7(A)

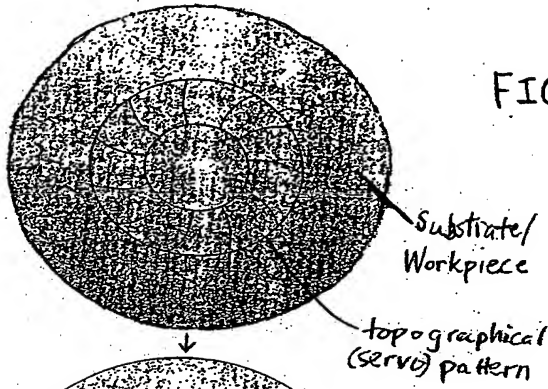
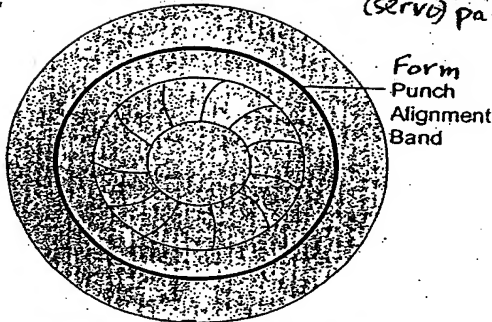


FIG. 8

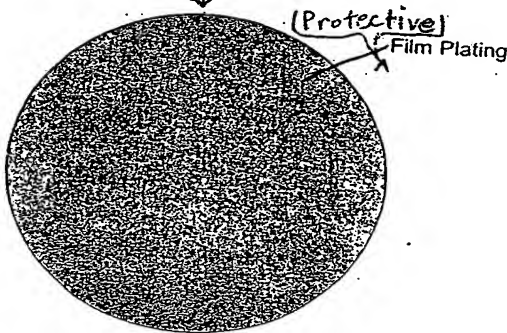
801  
Provide substrate/workpiece  
with topographical (servo)  
pattern formed in central  
area of surface

FIG. 7(B)



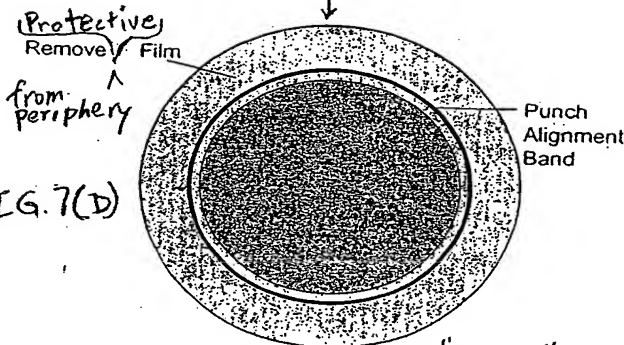
802  
Form alignment mark (band)  
surrounding pattern  
periphery  
Form layer of release  
material on surface

FIG. 7(C)



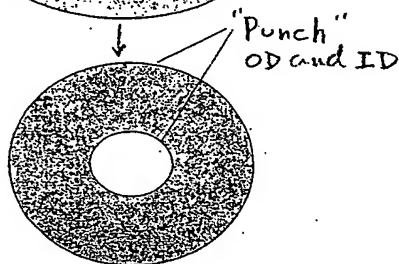
803  
Form protective film  
on surface of  
substrate/workpiece

FIG. 7(D)



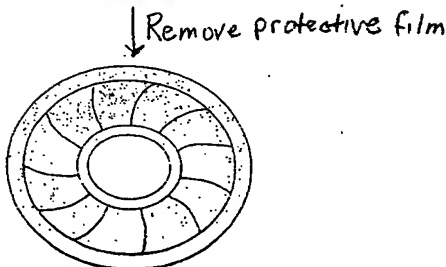
804  
Remove peripheral portion  
of protective film to  
expose alignment band

FIG. 7(E)



805  
"Punch" substrate/workpiece  
to form annular disk with  
Inner Diameter (ID) and  
Outer Diameter (OD)

FIG. 7(F)



806  
Remove protective film  
to expose topographical  
(servo) pattern prior to use